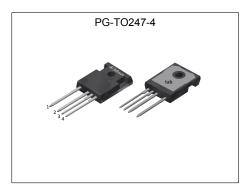


MOSFET

600V CoolMOS™ CM8 Power Transistor

The CoolMOS™ 8th generation platform is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. The 600V CoolMOS™ CM8 series is the successor to the CoolMOS™ 7. It combines the benefits of a fast switching SJ MOSFET with excellent ease of use, e.g low ringing tendency, implemented fast body diode (CFD) for all products with outstanding robustness against hard commutation and excellent ESD capability. Furthermore, extremely low switching and conduction losses of CM8, make switching applications even more efficient.



Features

- Suitable for hard and soft switching topologies thanks to an outstanding commutation ruggedness
- Significant reduction of switching and conduction losses
- Best in class R_{DS(on)} per package products enabled by ultra low R_{DS(on)}*A

Benefits

- Ease of use and fast design-in through low ringing tendency and usage across PFC and PWM stages
- Simplified thermal management thanks to our advanced die attach technique
- Increased power density solutions enabled by using products with smaller footprint and higher manufacturing quality due state of the art ESD protection
- Suitable for a wide variety of applications and power ranges

Potential applications

- Power supplies and converters
- PFC stages & LLC resonant converters
- High efficiency switching applications
- e.g. Server, Telecom, EV Charging, UPS

Product validation

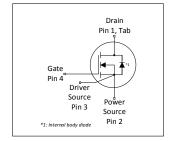
Fully qualified according to JEDEC for Industrial Applications

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.

Table 1 Key Performance Parameters

| rabie i itoj i diformando i aramotoro | | | | | | | | |
|---------------------------------------|-------|------|--|--|--|--|--|--|
| Parameter | Value | Unit | | | | | | |
| V _{DS} @ T _{j,max} | 650 | V | | | | | | |
| R _{DS(on),max} | 37 | mΩ | | | | | | |
| $Q_{g,typ}$ | 79 | nC | | | | | | |
| $I_{D,pulse}$ | 230 | A | | | | | | |
| E _{oss} @ 400V | 10.6 | μJ | | | | | | |
| Body diode di _F /dt | 1300 | A/µs | | | | | | |
| ESD class (HBM) | 2 | - | | | | | | |

| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|------------|----------|----------------|
| IPZA60R037CM8 | PG-TO247-4 | 60R037C8 | see Appendix A |









600V CoolMOS™ CM8 Power Transistor IPZA60R037CM8



Table of Contents

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| Thermal characteristics |
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600V CoolMOS™ CM8 Power Transistor IPZA60R037CM8



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum ratings**

| Davamatan | Cumbal | Values | | | 1114 | Note / Test Condition | |
|---|----------------------|--------|------|-----------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. Unit | | Note / Test Condition | |
| Continuous drain current ¹⁾ | I _D | - | - | 64 40 | A | T _C =25°C T _C =100°C | |
| Pulsed drain current ²⁾ | I _{D,pulse} | - | - | 230 | Α | T _C =25°C | |
| Avalanche energy, single pulse | E AS | - | - | 135 | mJ | I_D =7.8A; V_{DD} =50V; see table 10 | |
| Avalanche energy, repetitive | E AR | - | - | 0.68 | mJ | I_D =7.8A; V_{DD} =50V; see table 10 | |
| Avalanche current, single pulse | I _{AS} | - | - | 7.8 | Α | - | |
| MOSFET dv/dt ruggedness | dv/dt | - | - | 120 | V/ns | V _{DS} =0400V | |
| Gate source voltage (static) | V _{GS} | -20 | - | 20 | V | static; | |
| Gate source voltage (dynamic) | V _{GS} | -30 | - | 30 | V | AC (f>1 Hz) | |
| Power dissipation | P _{tot} | - | - | 329 | W | T _C =25°C | |
| Storage temperature | $T_{ m stg}$ | -55 | - | 150 | °C | - | |
| Operating junction temperature | T _j | -55 | - | 150 | °C | - | |
| Extended operating junction temperature | T _j | 150 | - | 175 | °C | ≤50 h in the application lifetime | |
| Mounting torque | - | - | - | 60 | Ncm | M3 and M3.5 screws | |
| Continuous diode forward current | Is | - | - | 64 | Α | T _C =25°C | |
| Diode pulse current ²⁾ | I _{S,pulse} | - | - | 230 | Α | T _C =25°C | |
| Reverse diode dv/dt ³⁾ | dv/dt | - | - | 70 | V/ns | $V_{\rm DS}$ =0400V, $I_{\rm SD}$ ≤64A, $T_{\rm j}$ =25°C see table 8 | |
| Maximum diode commutation speed | di _F /dt | - | - | 1300 | A/µs | $V_{\rm DS}$ =0400V, $I_{\rm SD}$ ≤64A, $T_{\rm j}$ =25°C see table 8 | |
| Insulation withstand voltage | V _{ISO} | - | - | n.a. | V | V _{rms} , T _C =25°C, <i>t</i> =1min | |

 $^{^{1)}}$ Limited by $T_{j,max}.$ $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical $R_{\rm G}$

600V CoolMOS[™] CM8 Power Transistor IPZA60R037CM8



2 Thermal characteristics

Table 3 Thermal characteristics

| Davamatav | Cumbal | Values | | | 11 | Nata / Tast Canditian | |
|--|-------------------|--------|------|------|------|-------------------------------------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Thermal resistance, junction - case | R _{thJC} | - | - | 0.38 | K/W | - | |
| Thermal resistance, junction - ambient | | - | - | 62 | K/W | leaded | |
| Thermal resistance, junction - ambient for SMD version | R _{thJA} | - | - | - | K/W | - | |
| Soldering temperature, wavesoldering only allowed at leads | T _{sold} | - | - | 260 | °C | 1.6mm (0.063 in.) from case for 10s | |

600V CoolMOS™ CM8 Power Transistor IPZA60R037CM8



3 Electrical characteristics at T_j =25°C, unless otherwise specified

Table 4 **Static characteristics**

| Damanastan | Ol | Values | | | | Nata / Table Open differen | |
|----------------------------------|-----------------------|--------|----------------|-------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Drain-source breakdown voltage | V _{(BR)DSS} | 600 | - | - | V | V_{GS} =0V, I_D =1mA | |
| Gate threshold voltage | V _{(GS)th} | 3.7 | 4.2 | 4.7 | V | $V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 0.68 {\rm mA}$ | |
| Zero gate voltage drain current | I _{DSS} | - | - 88.9 | 1 - | μΑ | V _{DS} =600V, V _{GS} =0V, T _j =25°C V _{DS} =600V, V _{GS} =0V, T _j =150°C | |
| Gate-source leakage current | I _{GSS} | - | - | 0.1 | μA | V _{GS} =20V, V _{DS} =0V | |
| Drain-source on-state resistance | R _{DS(on)} | - | 0.031 0.068 | 0.037 | Ω | V _{GS} =10V, I _D =27.0A, T _j =25°C V _{GS} =10V, I _D =27.0A, T _j =150°C | |
| Gate resistance | R _G | - | 1 | - | Ω | f=1MHz | |

Table 5 **Dynamic characteristics**

| Demonstra | Or smalle all | Values | | | 11 | N | |
|--|--------------------|--------|-------|------|------|--|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Input capacitance | Ciss | - | 3458 | - | pF | V _{GS} =0V, V _{DS} =400V, f=250kHz | |
| Output capacitance | Coss | - | 43 | - | pF | V _{GS} =0V, V _{DS} =400V, f=250kHz | |
| Effective output capacitance, energy related $C_{o(er)}$ - | | - | 133 | - | pF | V _{GS} =0V, V _{DS} =0400V | |
| Effective output capacitance, time related ²⁾ | C _{o(tr)} | - | 1371 | - | pF | I _D =constant, V _{GS} =0V, V _{DS} =0400V | |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 20.6 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.5A, $R_{\rm G}$ =5.3 Ω ; see table 9 | |
| Rise time | t _r | - | 7.6 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.5A, $R_{\rm G}$ =5.3 Ω ; see table 9 | |
| Turn-off delay time | $t_{ m d(off)}$ | - | 101.6 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.5A, $R_{\rm G}$ =5.3 Ω ; see table 9 | |
| Fall time | t _f | - | 5.8 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.5A, $R_{\rm G}$ =5.3 Ω ; see table 9 | |

Table 6 **Gate charge characteristics**

| Davamatar | Cumbal | | Values | | | Note / Took Condition | |
|-----------------------|----------------------|------|--------|------|------|--|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Gate to source charge | Q _{gs} | - | 21 | - | nC | V_{DD} =400V, I_{D} =13.5A, V_{GS} =0 to 10V | |
| Gate to drain charge | $Q_{ m gd}$ | - | 28 | - | nC | V_{DD} =400V, I_{D} =13.5A, V_{GS} =0 to 10V | |
| Gate charge total | Qg | - | 79 | - | nC | V_{DD} =400V, I_{D} =13.5A, V_{GS} =0 to 10V | |
| Gate plateau voltage | V _{plateau} | _ | 5.9 | - | V | V_{DD} =400V, I_{D} =13.5A, V_{GS} =0 to 10V | |

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

600V CoolMOS™ CM8 Power Transistor



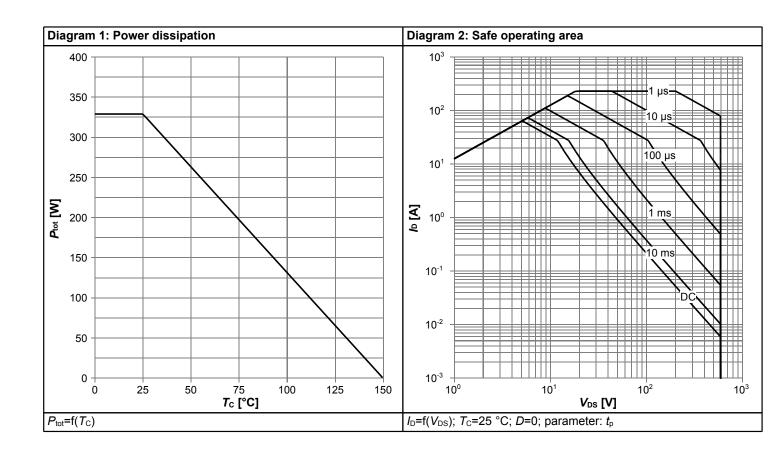


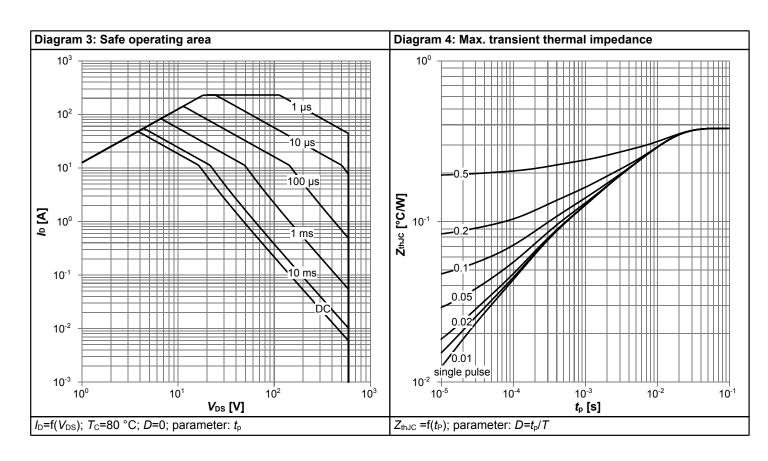
Table 7 Reverse diode characteristics

| Davamatav | Cymphal | Values | | | 11 | Nata / Tant Candition | |
|-------------------------------|------------------------|--------|------|------|------|--|--|
| Parameter | Symbol Min | | Тур. | Max. | Unit | Note / Test Condition | |
| Diode forward voltage | V _{SD} | - | 0.9 | - | V | V _{GS} =0V, I _F =13.5A, T _j =25°C | |
| Reverse recovery time | t _{rr} | - | 120 | 150 | ns | V_R =400V, I_F =13.5A, di_F/dt =100A/ μ s; see table 8 | |
| Reverse recovery charge | Q _{rr} | - | 0.73 | 1.10 | μC | V_R =400V, I_F =13.5A, di_F/dt =100A/ μ s; see table 8 | |
| Peak reverse recovery current | I _{rrm} | - | 11.8 | - | А | V_R =400V, I_F =13.5A, di_F/dt =100A/ μ s; see table 8 | |

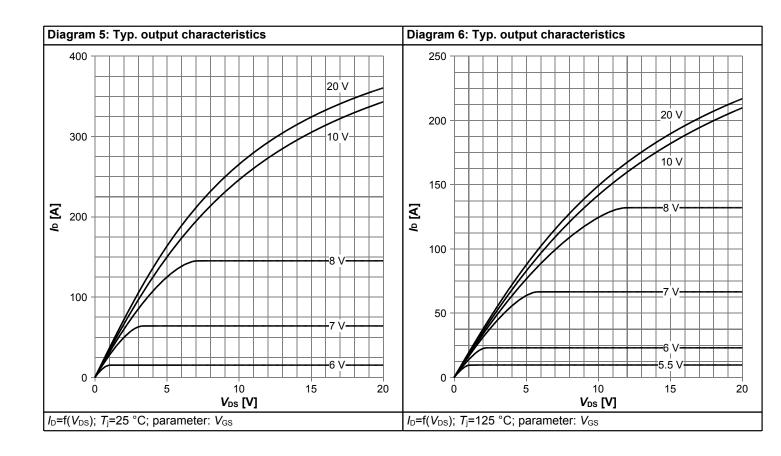


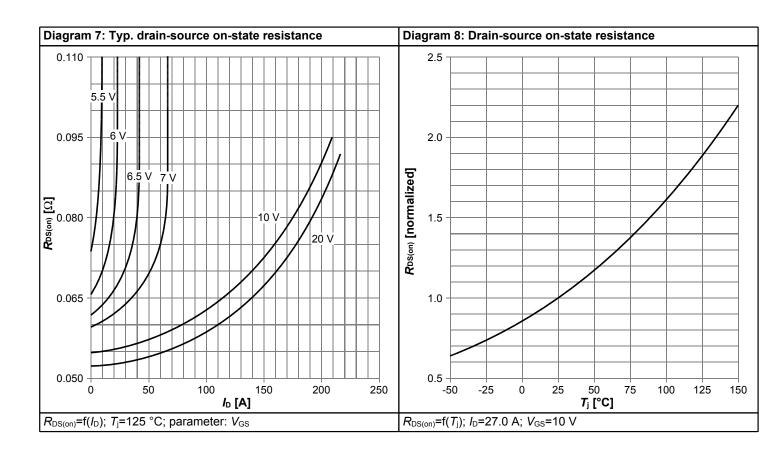
4 Electrical characteristics diagrams



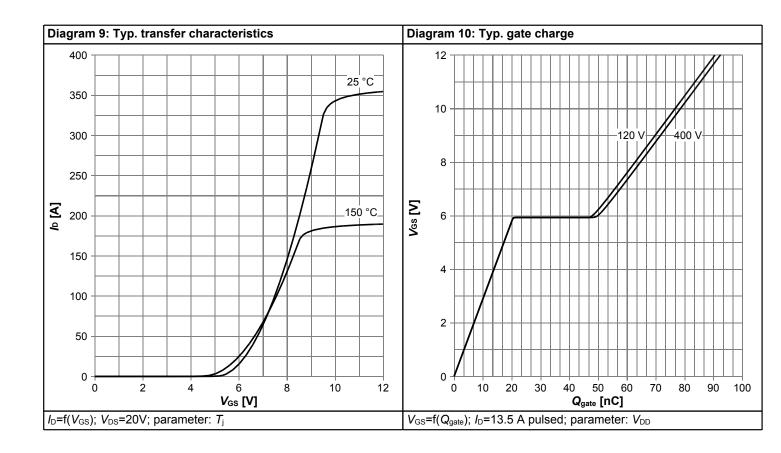


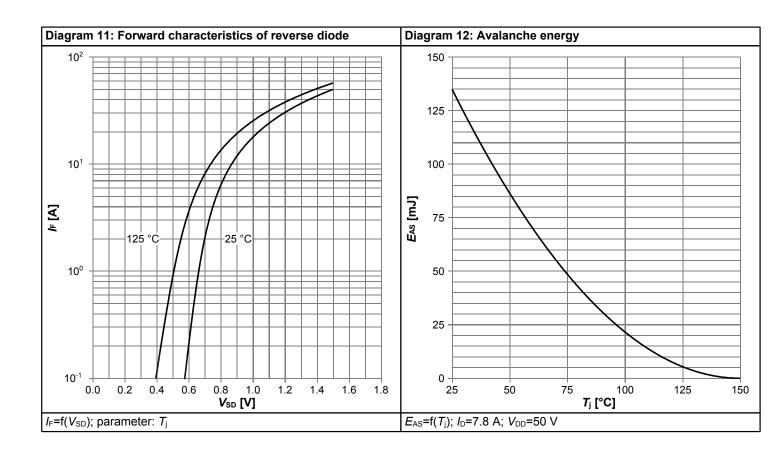




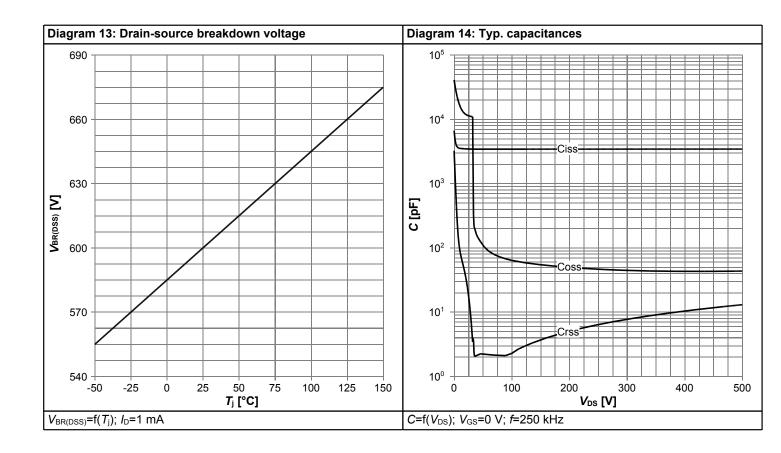


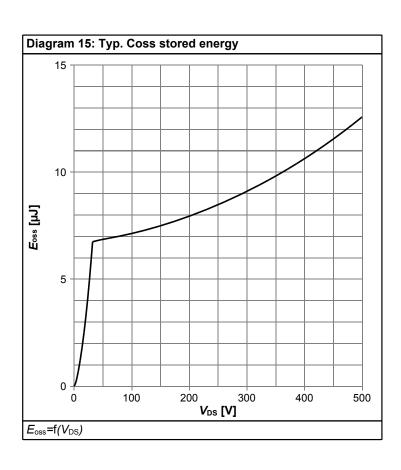














5 Test Circuits

Table 8 Diode characteristics

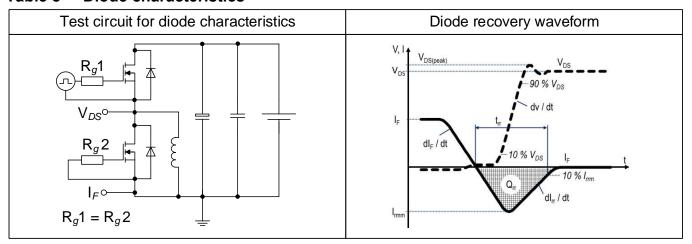


Table 9 Switching times (ss)

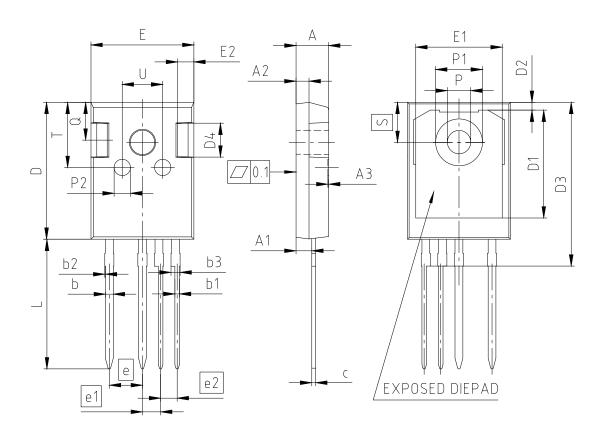


Table 10 Unclamped inductive load (ss)





6 Package Outlines



NOTES: DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS

| PACKAGE - GROUP NUMBER: | PG-TO2 | 47-4-U02 | | | |
|----------------------------|--------|----------|------------|--------|-------|
| DIMENSIONS | MILLIM | IETERS | DIMENSIONS | MILLIM | ETERS |
| DIMENSIONS | MIN. | MAX. | DINENSIONS | MIN. | MAX. |
| Α | 4.90 | 5.10 | E | 15.70 | 15.90 |
| A1 | 2.31 | 2.51 | E1 | 13.10 | 13.50 |
| A2 | 1.90 | 2.10 | E2 | 2.40 | 2.60 |
| A3 | 0.05 | 0.25 | е | 5.08 | |
| b | 1.10 | 1.30 | e1 | 2.79 | |
| b1 | 0.65 | 0.79 | e2 | 2.54 | |
| b2 | | 0.20 | N | 4 | |
| b3 | 1.34 | 1.44 | L | 19.80 | 20.10 |
| С | 0.58 | 0.66 | øΡ | 3.50 | 3.70 |
| D | 20.90 | 21.10 | øP1 | 7.00 | 7.40 |
| D1 | 16.25 | 16.85 | øP2 | 2.40 | 2.60 |
| D2 | 1.05 | 1.35 | Q | 5.60 | 6.00 |
| D3 | 24.97 | 25.27 | S | 6.15 | |
| D4 | 4.90 | 5.10 | Т | 9.80 | 10.20 |
| | | | U | 6.00 | 6.40 |

Figure 1 Outline PG-TO247-4, dimensions in mm

600V CoolMOS[™] CM8 Power Transistor IPZA60R037CM8



7 Appendix A

Table 11 Related Links

• IFX CoolMOS CM8 Webpage: www.infineon.com

• IFX CoolMOS CM8 application note: www.infineon.com

• IFX CoolMOS CM8 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

600V CoolMOS™ CM8 Power Transistor

IPZA60R037CM8



Revision History

IPZA60R037CM8

Revision: 2024-03-21, Rev. 2.1

| Previous | Revision |
|----------|----------|

| 1 10110401 | 1 To Nodo Trevioleti | | | | | | | |
|------------|----------------------|--|--|--|--|--|--|--|
| Revision | Date | Subjects (major changes since last revision) | | | | | | |
| 2.0 | 2023-10-25 | Release of final version | | | | | | |
| 2.1 | 2024-03-21 | Update of R _{thJC} | | | | | | |

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Final Data Sheet 14 Rev. 2.1, 2024-03-21